

PIM IGBT Module

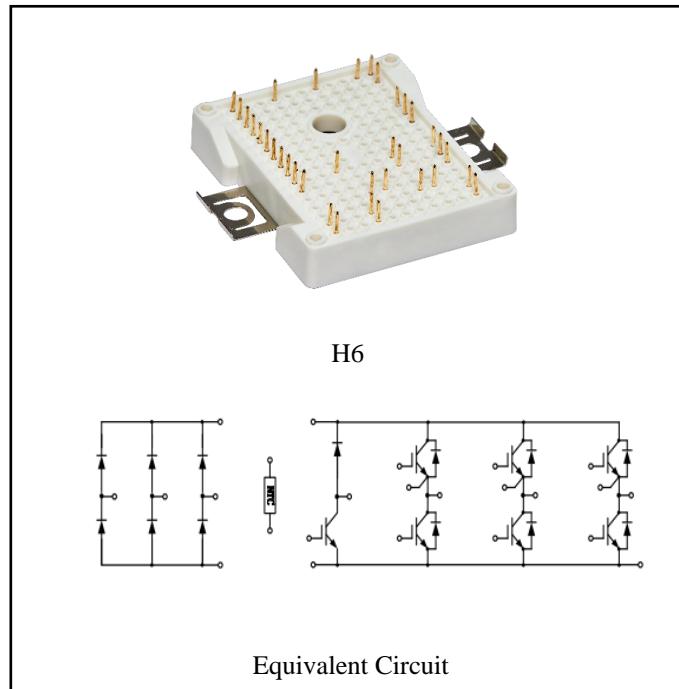
$V_{CES}=1200V$, $I_C \text{ nom}=25A$ / $I_{CRM}=50A$

Features :

- 1200V Trench /Field Stop process
- Low switching losses
- V_{cesat} has a positive temperature coefficient

Applications:

- Variable Frequency Drive
- Servo drive
- Inverter



IGBT, Inverter

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Collector-Emitter voltage	$T_{vj}=25^\circ C$	V_{CES}	1200	V
Continuous DC collector current	$T_c=100^\circ C$, $T_{vj \max}=175^\circ C$	$I_C \text{ nom}$	25	A
Repetitive peak collector current	$t_p=1 \text{ ms}$	I_{CRM}	50	A
Total power dissipation	$T_c = 25^\circ C$, $T_{vj \max} = 175^\circ C$	P_{tot}	175	W
Gate emitter voltage		V_{GE}	± 20	V

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	$V_{GE}=15V$, $I_c=25A$	V_{CEsat}		1.65	2.00	V
	$V_{GE}=15V$, $I_c=25A$			1.95		
	$V_{GE}=15V$, $I_c=25A$			2.00		
Gate-Emitter threshold voltage	$I_c=0.8mA$, $V_{GE}=V_{CE}$	$V_{GE(th)}$	5.2	5.85	6.4	

Internal gate resistor		R _{Gint}		None		Ω
Input capacitance	f=1MHz, V _{CE} =25V, V _{GE} =0 V T _{vj} =25°C	C _{ies}		1.67		nF
Reverse transfer capacitance		C _{res}		0.08		
Collector-emitter cut-off current	V _{CE} =1200V , V _{GE} = 0 V T _{vj} =25°C	I _{CES}			1	mA
Gate-emitter leakage current	V _{CE} =0 V, V _{GE} = 20 V T _{vj} =25°C	I _{GES}			100	nA
Turn-on delay time	I _c =25A, V _{CE} =600 V V _{GE} =±15 V, R _G =40Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _{d on}		63 58 54	ns
Rise time	I _c =25A, V _{CE} =600 V V _{GE} =±15 V, R _G =40Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _r		48 55 56	
Turn-off delay time	I _c =25A, V _{CE} =600 V V _{GE} =±15 V, R _G =40Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _{d off}		314 351 362	
Fall time	I _c =25A, V _{CE} =600 V V _{GE} =±15 V, R _G =40Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _f		191 301 313	
Turn-on energy loss per pulse	I _c =25A, V _{CE} =600 V V _{GE} =±15 V, R _G =40Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	E _{on}		2.88 4.44 4.74	mJ
Turn-off energy loss per pulse	I _c =25A, V _{CE} =600 V V _{GE} =±15 V, R _G =40Ω (inductive load)	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	E _{off}		1.66 2.14 2.31	
SC data	V _{GE} ≤15V, V _{CC} =800V V _{CEmax} =V _{CES} ·L _{sCE} ·di/dt t _p ≤8us, T _{vj} =150°C	I _{SC}		117		A
Thermal resistance, junction to case	per IGBT	R _{thJC}			0.85	K/W
Temperature under switching conditions		T _{vj op}	-40		150	°C

Diode, Inverter

Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
Repetitive peak reverse voltage	T _{vj} =25°C	V _{RRM}	1200	V
Continuous DC forward current		I _F	25	A
Repetitive peak forward current	t _p =1ms	I _{FRM}	50	A
I ² t-value	t _p =10ms, sin180° , T _j =125°C	I ² t	500	A ² s

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	I _F =25A, V _{GE} =0V	V _F		1.77	2.3	V
	I _F =25A, V _{GE} =0V			1.48		
	I _F =25A, V _{GE} =0V			1.41		
Peak reverse recovery current	I _F =25A,	I _{RM}	T _{vj} =25°C		15	A
	-dI/dt=333A/μs(T _{vj} =150°C)		T _{vj} =125°C		24	
	V _R =600V, V _{GE} =-15V		T _{vj} =150°C		26	
Recovered charge	I _F =25A,	Q _r	T _{vj} =25°C		1.97	μC
	-dI/dt=333A/μs(T _{vj} =150°C)		T _{vj} =125°C		5.28	
	V _R =600V, V _{GE} =-15V		T _{vj} =150°C		6.32	
Reverse recovered energy	I _F =25A,	E _{rec}	T _{vj} =25°C		0.64	mJ
	-dI/dt=333A/μs(T _{vj} =150°C)		T _{vj} =125°C		1.75	
	V _R =600V, V _{GE} =-15V		T _{vj} =150°C		2.12	
Thermal resistance, junction to case	per diode	R _{thJC}			1.20	K/W
Temperature under switching conditions		T _{vj op}	-40		150	°C

Diode, Rectifier
Maximum Ratings

Parameter	Conditions	Symbol	Value		Unit
Repetitive peak reverse voltage	T _{vj} =25°C	V _{RRM}	1600		V
Non-Repetitive peak reverse voltage	T _{vj} =25°C	V _{RSM}	1800		V
Maximum Average Forward Current		I _{F(AV)}	25		A
Surge forward current	t _p =10ms, sin180°, T _{vj} =25°C	I _{FSM}	320		A
I ² t-value	t _p =10ms, sin180°, T _{vj} =125°C	I ² t	850		A ² s

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	I _F =25A, T _{vj} =25°C	V _F			1.1	V
Reverse current	V _R =V _{RRM}	I _R			5	μA

Temperature under switching conditions		T _{vj op}	-40		150	°C
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IGBT, Brake-Chopper

Maximum Ratings

Parameter	Conditions	Symbol	Value		Unit
Collector-Emitter voltage	T _{vj} =25°C	V _{CES}	1200		V
Continuous DC collector current	T _C =100°C, T _{vj max} =175°C	I _{C nom}	25		A
Repetitive peak collector current	t _p =1 ms	I _{CRM}	50		A
Total power dissipation	T _C = 25°C, T _{vj max} = 175°C	P _{tot}	125		W
Gate emitter voltage		V _{GE}	±20		V

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Collector-Emitter saturation voltage	V _{GE} =15V, I _c =25A	T _{vj} =25°C	V _{CESat}	1.80	2.20	V
	V _{GE} =15V, I _c =25A				2.08	
	V _{GE} =15V, I _c =25A				2.15	
Gate-Emitter threshold voltage	I _c =1mA, V _{GE} = V _{CE}	T _{vj} =25°C	V _{GE(th)}	5.2	5.85	6.4
Internal gate resistor		R _{Gint}		None		Ω
Input capacitance	f=1MHz, V _{CE} =25 V, V _{GE} =0 V	T _{vj} =25°C	C _{ies}	1.66		nF
Reverse transfer capacitance			C _{res}	0.08		
Collector-emitter cut-off current	V _{CE} =1200V , V _{GE} = 0 V	T _{vj} =25°C	I _{CES}	1		mA
Gate-emitter leakage current	V _{CE} =0 V, V _{GE} = 20 V	T _{vj} =25°C	I _{GES}	100		nA
Turn-on delay time	I _c =25A, V _{CE} =600 V	T _{vj} =25°C	t _{d on}	65		ns
	V _{GE} =±15 V, R _G =40Ω	T _{vj} =125°C			60	
	(inductive load)	T _{vj} =150°C			56	
Rise time	I _c =25A, V _{CE} =600 V	T _{vj} =25°C	t _r	87		ns
	V _{GE} =±15 V, R _G =40Ω	T _{vj} =125°C			90	
	(inductive load)	T _{vj} =150°C			92	
Turn-off delay time	I _c =25A, V _{CE} =600 V	T _{vj} =25°C	t _{d off}	301		
	V _{GE} =±15 V, R _G =40Ω	T _{vj} =125°C			350	
	(inductive load)	T _{vj} =150°C			355	

Fall time	$I_C=25A$, $V_{CE}=600V$ $V_{GE}=\pm 15V$, $R_G=40\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	t_f		231 302 290		
Turn-on energy loss per pulse	$I_C=25A$, $V_{CE}=600V$ $V_{GE}=\pm 15V$, $R_G=40\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	E_{on}		2.34 2.73 2.90		mJ
Turn-off energy loss per pulse	$I_C=25A$, $V_{CE}=600V$ $V_{GE}=\pm 15V$, $R_G=40\Omega$ (inductive load)	$T_{vj}=25^\circ C$ $T_{vj}=125^\circ C$ $T_{vj}=150^\circ C$	E_{off}		1.66 2.16 2.30		
Thermal resistance, junction to case	per IGBT		R_{thJC}			1.2	K/W
Temperature under switching conditions			$T_{vj\ op}$	-40		150	°C

Diode, Brake-Chopper

Maximum Ratings

Parameter	Conditions	Symbol	Value		Unit
Repetitive peak reverse voltage	$T_{vj}=25^\circ C$	V_{RRM}	1200		V
Continuous DC forward current		I_F	8		A
Repetitive peak forward current	$t_p=1ms$	I_{FRM}	16		A
I^2t -value	$V_R=0V$, $t_p=10ms$, $T_{vj}=125^\circ C$	I^2t	30		A^2s

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	$I_F=8A$, $V_{GE}=0V$	V_F		2.03	2.50	V
	$I_F=8A$, $V_{GE}=0V$			1.70		
	$I_F=8A$, $V_{GE}=0V$			1.63		
Peak reverse recovery current	$I_F=8A$,	I_{RM}	$T_{vj}=25^\circ C$	8		A
	$-dI/dt=217A/\mu s$ ($T_{vj}=150^\circ C$)		$T_{vj}=125^\circ C$	10		
	$V_R=600V$, $V_{GE}=-15V$		$T_{vj}=150^\circ C$	11		
Recovered charge	$I_F=8A$,	Q_r	$T_{vj}=25^\circ C$	0.74		μC
	$-dI/dt=217A/\mu s$ ($T_{vj}=150^\circ C$)		$T_{vj}=125^\circ C$	1.33		
	$V_R=600V$, $V_{GE}=-15V$		$T_{vj}=150^\circ C$	1.61		
Reverse recovered energy	$I_F=8A$,	E_{rec}	$T_{vj}=25^\circ C$	0.27		mJ
	$-dI/dt=217A/\mu s$ ($T_{vj}=150^\circ C$)		$T_{vj}=125^\circ C$	0.45		
	$V_R=600V$, $V_{GE}=-15V$		$T_{vj}=150^\circ C$	0.56		

Thermal resistance, junction to case	per diode	R _{thJC}			1.90	K/W
Temperature under switching conditions		T _{vj op}	-40		150	°C

NTC-Thermistor

Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Rated resistances	T _c =25°C, ±5%	R ₂₅		5.0		KΩ
B-value	±1%	B _{25/50}		3380		K

Module

Parameter	Conditions	Symbol	Value			Unit
Isolation test voltage	RMS, f=50Hz, t=1min	V _{ISOL}	2500			V
Internal isolation			Al ₂ O ₃			
Storage temperature		T _{stg}	-40		125	°C
Mounting torque for modul mounting		M	3.0		6.0	Nm
Weight		W		170		g

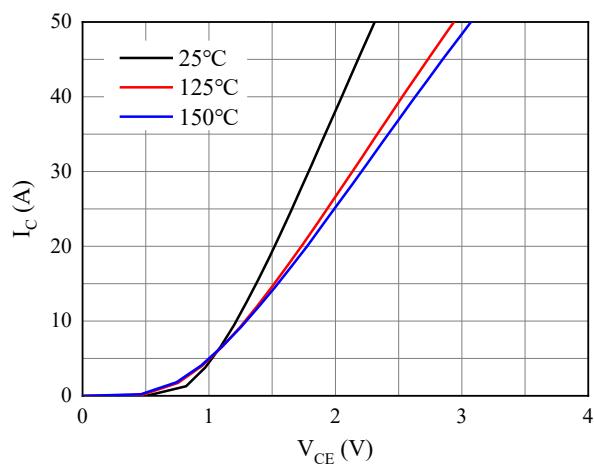


Fig 1. Typical output characteristics ($V_{GE}=15V$)

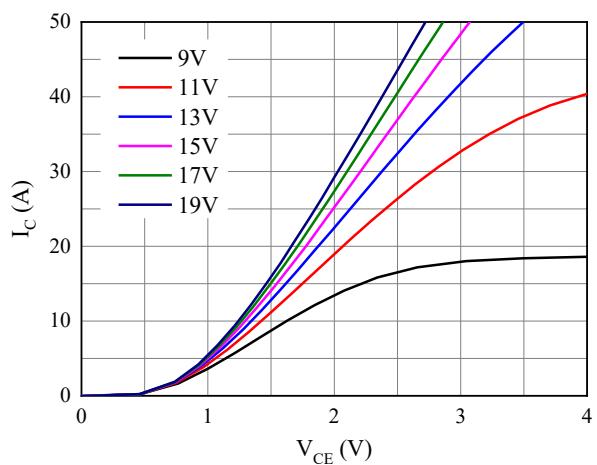


Fig 2. Typical output characteristics ($T_{vj}=150^\circ\text{C}$)

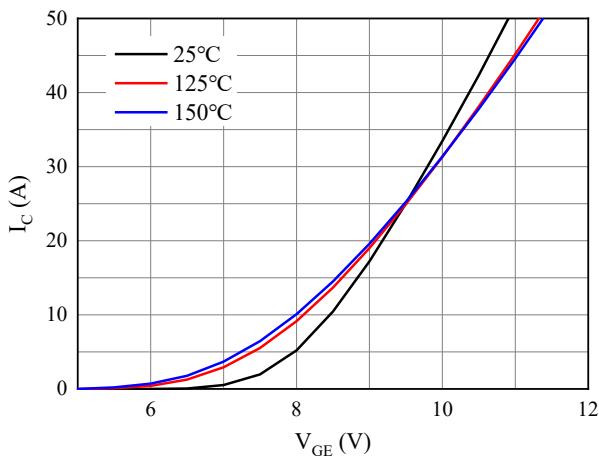


Fig 3. Typical transfer characteristic($V_{CE}=20V$)

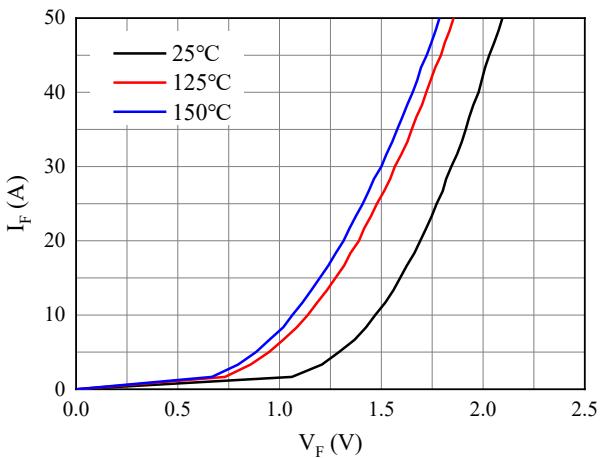


Fig 4. Forward characteristic of Diode

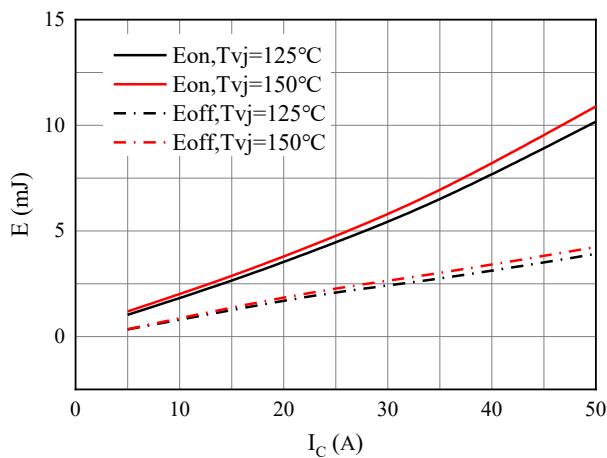


Fig 5. Switching losses of IGBT
 $V_{GE} = \pm 15V$, $R_{Gon} = 40\Omega$, $R_{Goff} = 40\Omega$, $V_{CE} = 600V$

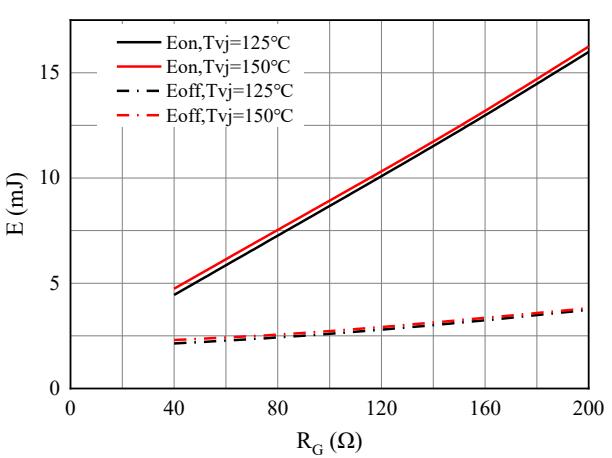


Fig 6. Switching losses of IGBT
 $V_{GE} = \pm 15V$, $I_C = 25A$, $V_{CE} = 600V$

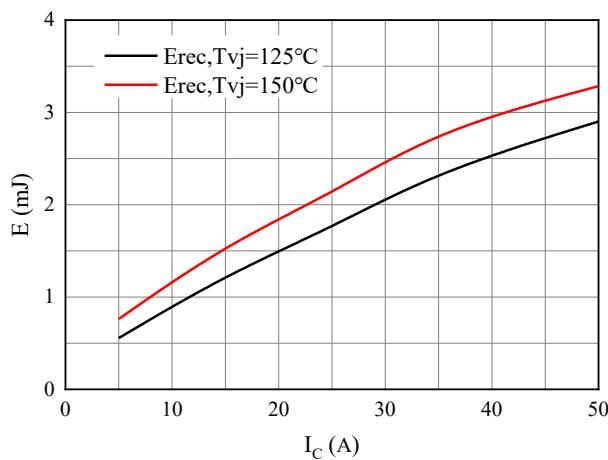


Fig 7. Switching losses of Diode
 $R_{Gon}=40\Omega$, $V_{CE}=600V$

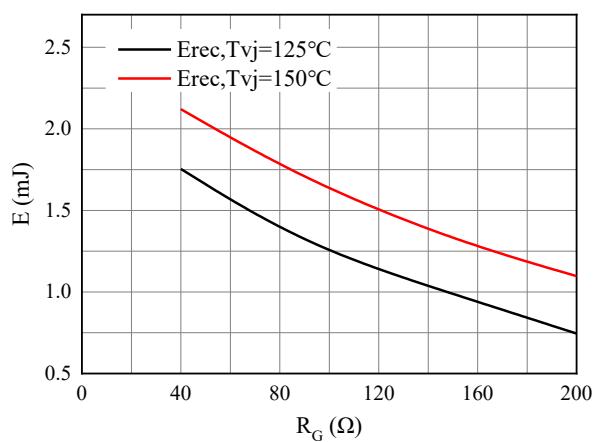


Fig 8. Switching losses of Diode
 $IF=25A$, $V_{CE}=600V$

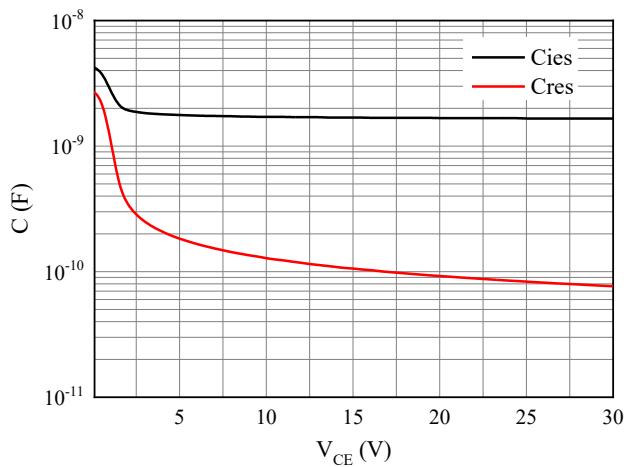


Fig 9. Capacitance characteristic

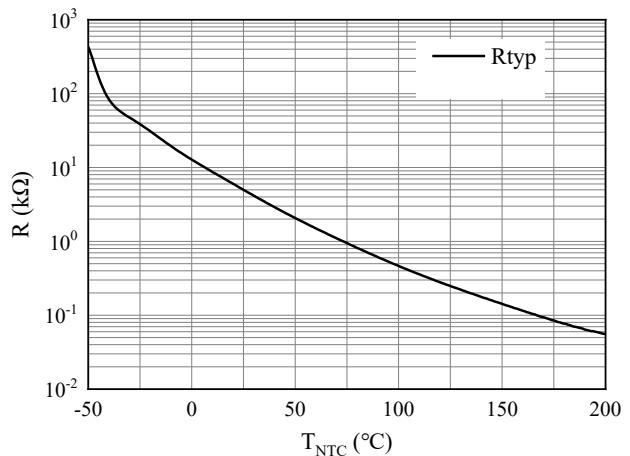
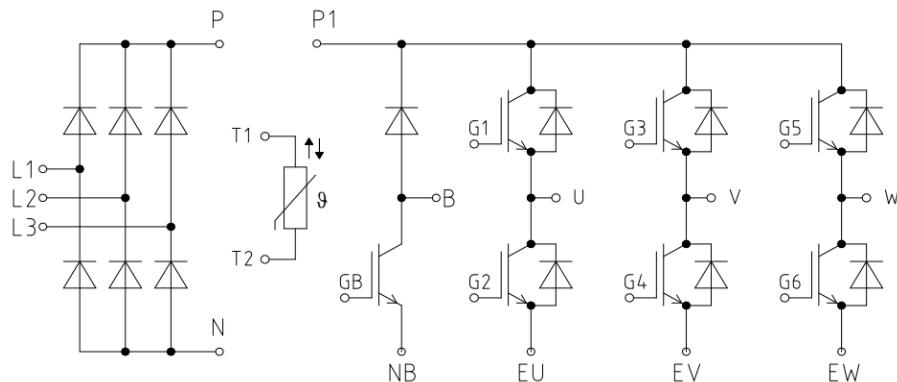


Fig 10. NTC-Thermistor-temperature characteristic

Circuit diagram



Package outlines

